**DAIKIN MALAYSIA GROUP SCHOLARSHIP PROGRAM 2025**

1. **Eligibility Criteria:**
2. Malaysian citizen.
3. Full-time student pursuing a Bachelor’s Degree at a Malaysian university (priority given to IPTA, followed by IPTS)
4. Possess good academic results:
5. **Students who will enroll into 1st year degree program**

* SPM or equivalent: **Minimum** **6As** + pass all subjects, with good results in **Mathematics, English, and Bahasa Malaysia.**
* STPM/Pre-University/Local Matriculation/Diploma/Foundation: **Minimum CGPA 3.00 & above.**
* MUET: Minimum **Band 4.**

1. **Students currently pursuing 1st year degree program**

* SPM or equivalent: **Minimum 6As** + passes in all subjects, with good results in Mathematics, English, and Bahasa Malaysia.
* STPM or equivalent: **Minimum 2As** + passes in all subjects.
* MUET: **Minimum Band 4.**
* Minimum GPA or CGPA: **3.00 & above.**

1. Active participation in co-curricular activities and demonstrated leadership.
2. Have not received other financial aid from any organization
3. Scholars who are free from any future employment obligations
4. Students who meet the above criteria (a to g) are welcome to apply. Preference will be given to students from families with a household income of RM5,000 per month or below.
5. **Eligible Courses:**

Bachelor’s Degree in:

1. Engineering (Preferably in Electrical & Electronics, Mechanical, Manufacturing, Mechatronics)
2. IT/Computer Science/Software Engineering/Data Science/Data Analytics
3. Accounting
4. Business/Management
5. **Scholar’s Obligations:**
6. Serves a bond with company offering the scholarship for a minimum of duration sponsor.
7. The bond will start immediately upon completion of degree course with the appointment letter given within 3 months period.
8. Scholar will be required to work in the sponsor company or any subsidiary companies within Daikin Malaysia Group.
9. Perform internship in the sponsor company or at any subsidiary within Daikin Malaysia Group during semester breaks.
10. Scholar shall reimburse 100% of the scholarship fees should he/she resign from the company or is terminated during the bond period.
11. **How to apply:**
12. Download the application form from <https://www.daikinmalaysia.com/career/scholarship-program/>
13. Submit applications by **15th November 2025.**
14. Submit via:

* Softcopy: Email to [daikin.scholarship@daikin.com.my](mailto:daikin.scholarship@daikin.com.my) (PDF format).

**or**

* Hardcopy: Send to:

**Attention: Ms. Farah Syuhada Binti Mohd Rosli / Ms. Nurul Afidza Binti Ismail/**

**Ms. Kay Lee Yen Hui / Ms. Chong Pui Theng**

**(Human Resources Department)**

**DAIKIN MALAYSIA SDN. BHD.**

Lot 60334, Persiaran Bukit Rahman Putra 3,

Taman Perindustrian Bukit Rahman Putra,

47000 Sungai Buloh, Selangor D.E. Malaysia.

**Download Application Form as Below:**

* Daikin Malaysia Group Scholarship Program 2025 - Application Form (Excel).
* Daikin Malaysia Group Scholarship Program 2025 - Application Form (PDF).

1. **Selection Process:**
2. Shortlisted candidate will be notified within 2 weeks after the application deadline.
3. Final selection will be based on interview results.

***\*Note: Applications will not be processed if:***

1. Documents are incomplete.
2. Candidates do not meet the criteria at para 1.
3. Applications are received after the deadline.
4. **Scholarship Amount:**

* **RM15,000** per annum for 1 scholar

1. **For Inquiries:**

* Email to [daikin.scholarship@daikin.com.my](mailto:daikin.scholarship@daikin.com.my)
* Contact us:
* Ms. Nurul Afidza Binti Ismail (03-6145 8616)
* Ms. Farah Syuhada Binti Mohd Rosli (03-6145 8378)
* Ms. Kay Lee Yen Hui (603-6145 8632)
* Ms. Chong Pui Theng (603-6145 8603)